

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takafumi Kawano	05/16/2011
Masataka Yamanaga	05/16/2011
Atsushi Okabe	05/16/2011
RECEIVING PARTY DATA	
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State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13131119
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Total Attachments: 1 source=00926243#page1.tif	

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INVENTION/PATENT APPLICATION ASSIGNMENT
FROM INVENTOR(S) TO COMPANY

WHEREAS I/WE Takafumi KAWANO of Yamaguchi, Japan, Masataka YAMANAGA of Yamaguchi, Japan, Atsushi OKABE of Yamaguchi, Japan, respectively, have made a certain new and useful invention as set forth in an application for United States Letters Patent, entitled: *DIELECTRIC CERAMIC COMPOSITION FOR HIGH-FREQUENCY USE AND METHOD FOR PRODUCING THE SAME, AS WELL AS DIELECTRIC CERAMIC FOR HIGH-FREQUENCY USE AND METHOD FOR PRODUCING THE SAME AND HIGH-FREQUENCY CIRCUIT ELEMENT USING THE SAME*, executed by us on the date of execution of this document, as shown below, and filed concurrently herewith;

OR

for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____;

AND WHEREAS, UBE INDUSTRIES, LTD. a corporation of the State of Japan and having an address of 1978-96, Oaza Kogushi, Ube-shi, Yamaguchi, Japan, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention and in and to any and all Letters Patent of the United States and foreign countries that may be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt for and sufficiency of which is hereby acknowledged, We do hereby sell, assign, transfer and set over unto said assignee, its legal representatives, successors, and assigns, the entire right, title and interest in and to said invention as set forth in the above-mentioned application, including any continuations, continuations-in-part, divisions, reissues, re-examinations or extensions thereof, and in and to any and all patents of the United States and foreign countries that may be issued for said invention;

UPON SAID CONSIDERATIONS, We hereby agree with the said assignee that We will not execute any writing or do any act whatsoever conflicting with these presents, and that We will, at any time upon request, without further or additional consideration but at the expense of said assignee, execute such additional assignments and other writings and do such additional acts as said assignee may deem necessary or desirable to perfect the assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuations, continuations-in-part, reexamined, reissued, or extended Letters Patent of the United States or of any and all foreign countries on said invention, and in enforcing any rights or causes of action accruing as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of the assigns and legal representatives of assignor and assignee;

AND We request the Commissioner of Patents and Trademarks to issue any Letters Patent of the United States that may be issued for said invention to said assignee, its legal representatives, successors or assigns, as the sole owner of the entire right, title and interest in and to said patent and the invention covered thereby.

Date May 16, 2011

Date May 16, 2011

Date May 16, 2011

Date

Signature Takafumi KAWANO

Signature Masataka YAMANAGA

Signature Atsushi OKABE

Signature Atsushi OKABE

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